

Low power dual operational amplifiers

Features

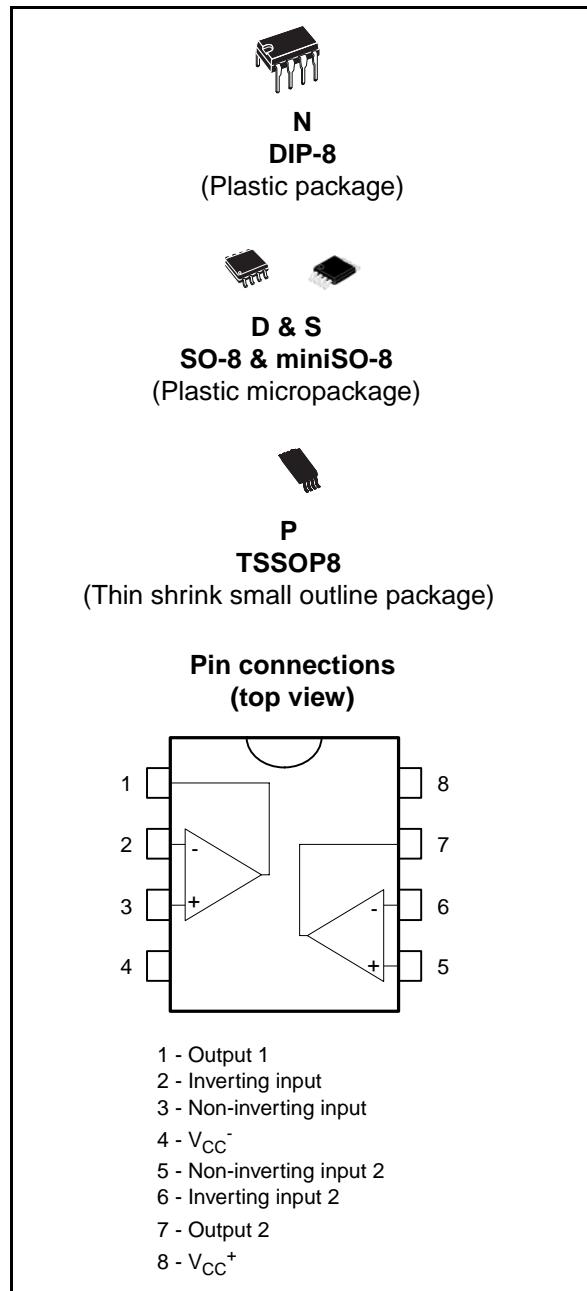
- Internally frequency compensated
- Large DC voltage gain: 100 dB
- Wide bandwidth (unity gain): 1.1 MHz (temperature compensated)
- Very low supply current per operator essentially independent of supply voltage
- Low input bias current: 20 nA (temperature compensated)
- Low input offset voltage: 2 mV
- Low input offset current: 2 nA
- Input common-mode voltage range includes ground
- Differential input voltage range equal to the power supply voltage
- Large output voltage swing 0 V to $V_{CC}^+ - 1.5$ V
- ESD internal protection: 1.5 kV

Description

These circuits consist of two independent, high-gain, internally frequency-compensated which were designed specifically to operate from a single power supply over a wide range of voltages. The low power supply drain is independent of the magnitude of the power supply voltage.

Application areas include transducer amplifiers, DC gain blocks and all the conventional op-amp circuits which now can be more easily implemented in single power supply systems. For example, these circuits can be directly supplied with the standard +5 V which is used in logic systems and will easily provide the required interface electronics without requiring any additional power supply.

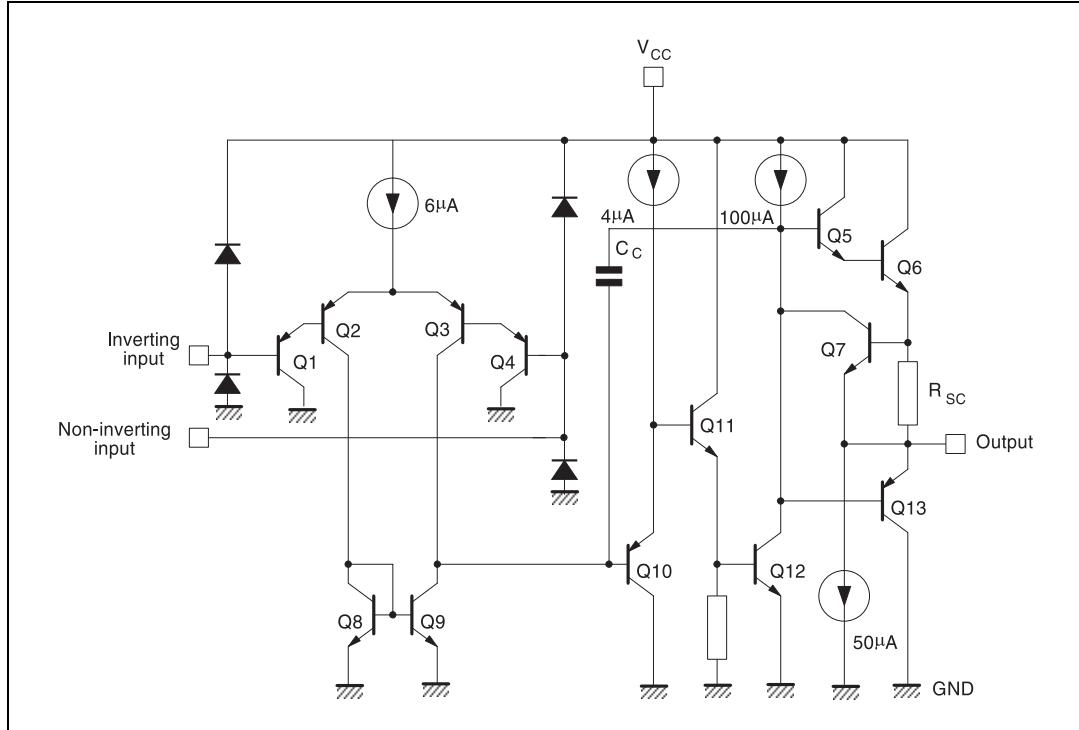
In the linear mode the input common-mode voltage range includes ground and the output



voltage can also swing to ground, even though operated from only a single power supply voltage.

1 Schematic diagram

Figure 1. Schematic diagram (1/2 LM158W)



2 Absolute maximum ratings and operating conditions

Table 1. Absolute maximum ratings

Symbol	Parameter	LM158W/AW	LM258W/AW	LM358W/AW	Unit
V_{CC}^+	Supply voltage	+32			V
V_{in}	Input voltage	-0.3 to V_{CC}^+ +0.3			V
V_{id}	Differential input voltage	-0.3 to V_{CC}^+ +0.3			V
	Output short-circuit duration ⁽¹⁾	Infinite			
I_{in}	Input current ⁽²⁾	50			mA
T_{oper}	Operating free-air temperature range	-55 to +125	-40 to +105	0 to +70	°C
T_{stg}	Storage temperature range	-65 to +150			°C
T_j	Maximum junction temperature	150			°C
R_{thja}	Thermal resistance junction to ambient ⁽³⁾ SO-8 MiniSO-8 TSSOP8 DIP-8	125 190 120 85			°C/W
R_{thjc}	Thermal resistance junction to case ⁽³⁾ SO-8 MiniSO-8 TSSOP8 DIP-8	40 39 37 41			°C/W
ESD	HBM: human body model ⁽⁴⁾	1.5			kV
	MM: machine model ⁽⁵⁾	200			V
	CDM: charged device model ⁽⁶⁾	1.5			kV

- Short-circuits from the output to V_{CC} can cause excessive heating if $V_{CC} > 15V$. The maximum output current is approximately 40 mA independent of the magnitude of V_{CC} . Destructive dissipation can result from simultaneous short-circuits on all amplifiers.
- This input current only exists when the voltage at any of the input leads is driven negative. It is due to the collector-base junction of the input PNP transistor becoming forward biased and thereby acting as input diode clamps. In addition to this diode action, there is also NPN parasitic action on the IC chip. This transistor action can cause the output voltages of the Op-amps to go to the V_{CC} voltage level (or to ground for a large overdrive) for the time during which an input is driven negative. This is not destructive and normal output will be restored for input voltage higher than -0.3 V.
- Short-circuits can cause excessive heating and destructive dissipation. R_{th} are typical values.
- Human body model: 100 pF discharged through a 1.5 kΩ resistor between two pins of the device, done for all couples of pin combinations with other pins floating.
- Machine model: a 200 pF cap is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor $< 5 \Omega$), done for all couples of pin combinations with other pins floating.
- Charged device model: all pins plus package are charged together to the specified voltage and then discharged directly to the ground.

Table 2. Operating conditions

Symbol	Parameter	Value	Unit
V_{CC}^+	Supply voltage	3 to 30	V
V_{icm}	Common mode input voltage range	$V_{DD} -0.3$ to $V_{CC} -1.5$	V
T_{oper}	Operating free air temperature range LM158W LM258W LM358W	-55 to +125 -40 to +105 0 to +70	°C

3 Electrical characteristics

Table 3. $V_{CC}^+ = +5\text{ V}$, $V_{CC}^- = \text{Ground}$, $V_o = 1.4\text{ V}$, $T_{amb} = +25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{io}	Input offset voltage ⁽¹⁾ LM158AW LM258AW, LM358AW LM158W, LM258W LM358W $T_{min} \leq T_{amb} \leq T_{max}$ LM158AW, LM258AW, LM358AW LM158W, LM258W LM358W		1 1 2 2	2 3 5 7 4 7 9	mV
DV_{io}	Input offset voltage drift LM158AW, LM258AW, LM358AW LM158W, LM258W, LM358W		7 7	15 30	$\mu\text{V}/^\circ\text{C}$
I_{io}	Input offset current LM158AW, LM258AW, LM358AW LM158W, LM258W, LM358W $T_{min} \leq T_{amb} \leq T_{max}$ LM158AW, LM258AW, LM358AW LM158W, LM258W, LM358W		2 2	10 30 30 40	nA
DI_{io}	Input offset current drift LM158AW, LM258AW, LM358AW LM158W, LM258W, LM358W		10 10	200 300	$\text{pA}/^\circ\text{C}$
I_{ib}	Input bias current ⁽²⁾ LM158AW, LM258AW, LM358AW LM158W, LM258W, LM358W $T_{min} \leq T_{amb} \leq T_{max}$ LM158AW, LM258AW, LM358AW LM158W, LM258W, LM358W		20 20	50 150 100 200	nA
A_{vd}	Large signal voltage gain $V_{CC}^+ = +15\text{ V}$, $R_L = 2\text{ k}\Omega$, $V_o = 1.4\text{ V}$ to 11.4 V $T_{min} \leq T_{amb} \leq T_{max}$	50 25	100		V/mV
SVR	Supply voltage rejection ratio $R_s \leq 10\text{ k}\Omega$, $V_{CC}^+ = 5\text{ V}$ to 30 V $T_{min} \leq T_{amb} \leq T_{max}$	65 65	100		dB
I_{CC}	Supply current, all amp, no load $T_{min} \leq T_{amb} \leq T_{max}$, $V_{CC}^+ = +5\text{ V}$ $T_{min} \leq T_{amb} \leq T_{max}$, $V_{CC}^+ = +30\text{ V}$		0.7	1.2 2	mA
V_{icm}	Input common mode voltage range $V_{CC}^+ = +30\text{ V}$ ⁽³⁾ $T_{amb} = +25^\circ\text{C}$ $T_{min} \leq T_{amb} \leq T_{max}$	0 0		$V_{CC}^+ - 1.5$ $V_{CC}^+ - 2$	V

Table 3. $V_{CC}^+ = +5\text{ V}$, $V_{CC}^- = \text{Ground}$, $V_o = 1.4\text{ V}$, $T_{amb} = +25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
CMR	Common mode rejection ratio $R_s \leq 10\text{k}\Omega$ $T_{min} \leq T_{amb} \leq T_{max}$	70 60	85		dB
I_{source}	Output current source $V_{CC}^+ = +15\text{ V}$, $V_o = +2\text{ V}$, $V_{id} = +1\text{ V}$	20	40	60	mA
I_{sink}	Output sink current $V_{CC}^+ = +15\text{V}$, $V_o = +2\text{V}$, $V_{id} = -1\text{ V}$ $V_{CC}^+ = +15\text{V}$, $V_o = +0.2\text{V}$, $V_{id} = -1\text{ V}$	10 12	20 50		mA μA
V_{OH}	High level output voltage $R_L = 2\text{k}\Omega$, $V_{CC}^+ = 30\text{ V}$ $T_{min} \leq T_{amb} \leq T_{max}$ $R_L = 10\text{k}\Omega$, $V_{CC}^+ = 30\text{ V}$ $T_{min} \leq T_{amb} \leq T_{max}$	26 26 27 27	27 28		V
V_{OL}	Low level output voltage $R_L = 10\text{k}\Omega$ $T_{min} \leq T_{amb} \leq T_{max}$		5 20 20		mV
SR	Slew rate $V_{CC}^+ = 15\text{ V}$, $V_i = 0.5$ to 3 V , $R_L = 2\text{k}\Omega$ $C_L = 100\text{ pF}$, unity gain	0.3	0.6		$\text{V}/\mu\text{s}$
GBP	Gain bandwidth product $V_{CC}^+ = 30\text{ V}$, $f = 100\text{ kHz}$, $V_{in} = 10\text{ mV}$, $R_L = 2\text{k}\Omega$ $C_L = 100\text{ pF}$	0.7	1.1		MHz
THD	Total harmonic distortion $f = 1\text{ kHz}$, $A_v = 20\text{ dB}$, $R_L = 2\text{k}\Omega$, $V_o = 2\text{ V}_{pp}$, $C_L = 100\text{ pF}$, $V_O = 2\text{ V}_{pp}$		0.02		%
e_n	Equivalent input noise voltage $f = 1\text{ kHz}$, $R_s = 100\text{ }\Omega$, $V_{CC}^+ = 30\text{ V}$		55		$\frac{\text{nV}}{\sqrt{\text{Hz}}}$
V_{o1}/V_{o2}	Channel separation ⁽⁴⁾ $1\text{ kHz} \leq f \leq 20\text{ kHz}$		120		dB

1. $V_o = 1.4\text{ V}$, $R_s = 0\text{ }\Omega$, $5\text{ V} < V_{CC}^+ < 30\text{ V}$, $0 < V_{ic} < V_{CC}^+ - 1.5\text{ V}$

2. The direction of the input current is out of the IC. This current is essentially constant, independent of the state of the output so there is no change in the load on the input lines.

3. The input common-mode voltage of either input signal voltage should not be allowed to go negative by more than 0.3 V . The upper end of the common-mode voltage range is $V_{CC}^+ - 1.5\text{ V}$, but either or both inputs can go to $+32\text{ V}$ without damage.

4. Due to the proximity of external components ensure that there is no coupling originating via stray capacitance between these external parts. Typically, this can be detected at higher frequencies because then this type of capacitance increases.

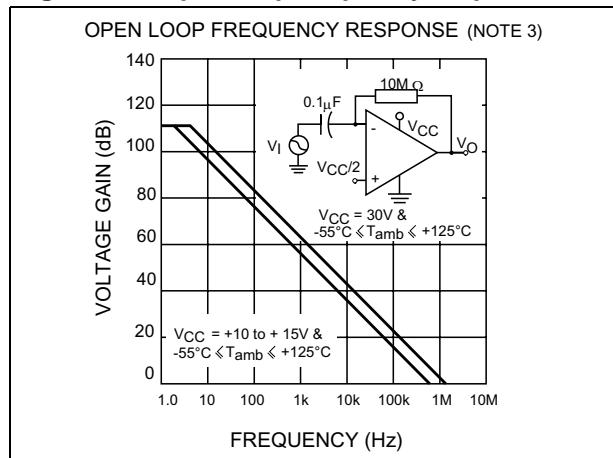
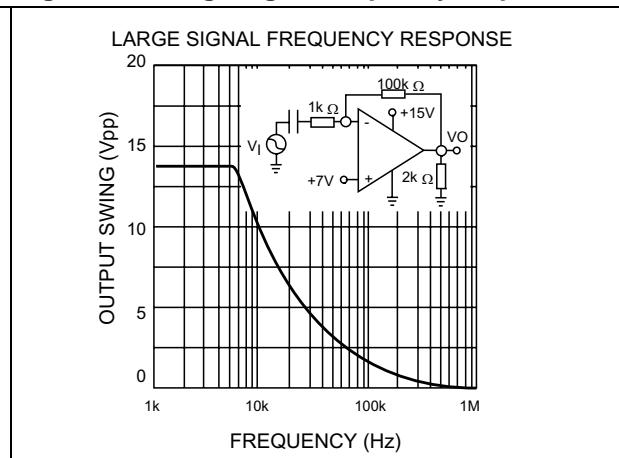
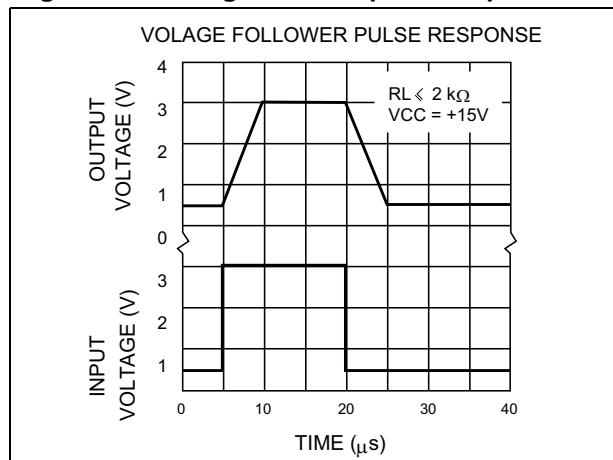
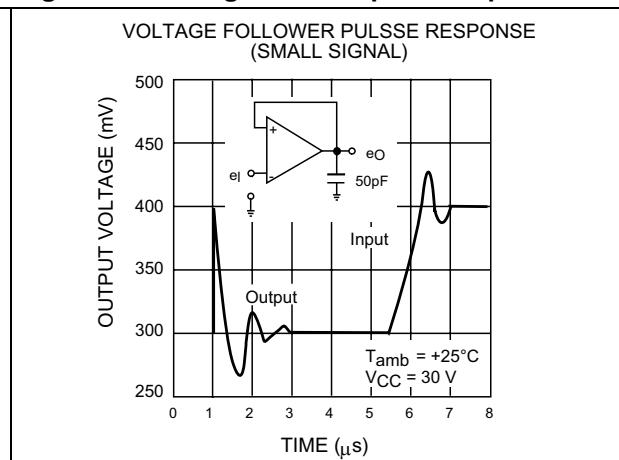
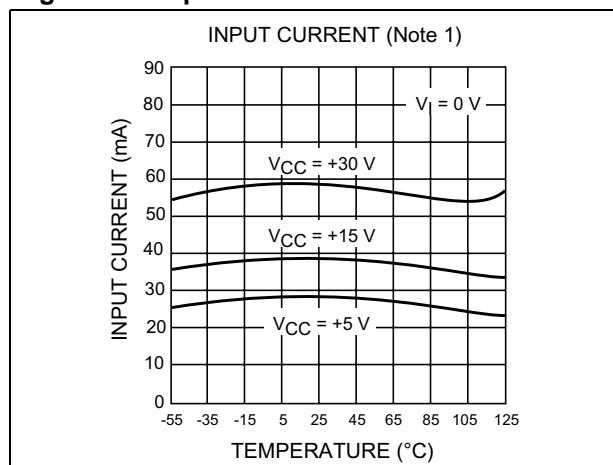
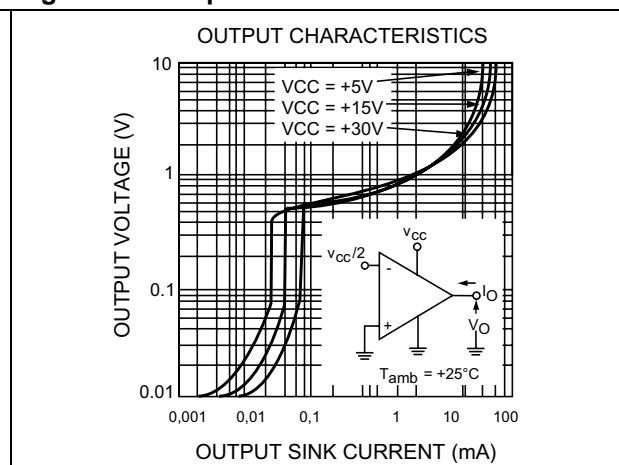
Figure 2. Open loop frequency response**Figure 3. Large signal frequency response****Figure 4. Voltage follower pulse response****Figure 5. Voltage follower pulse response****Figure 6. Input current****Figure 7. Output characteristics**

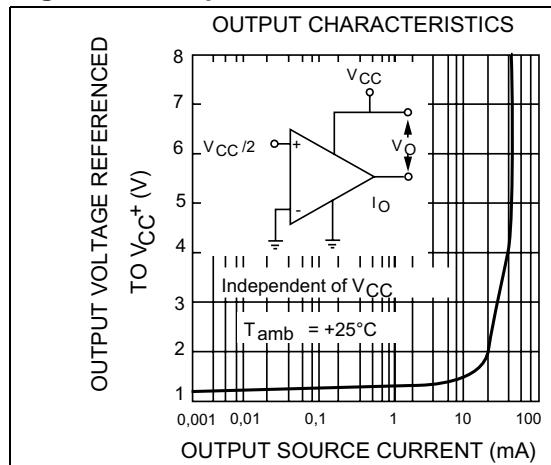
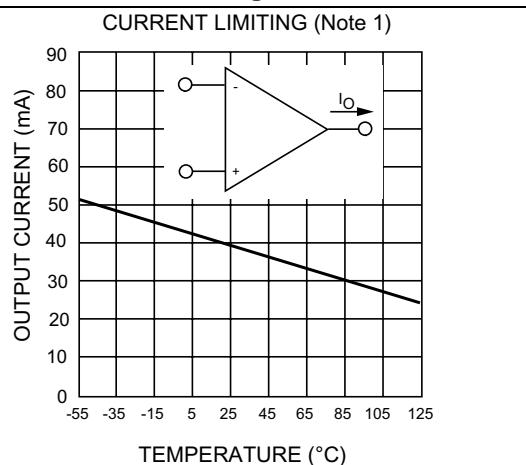
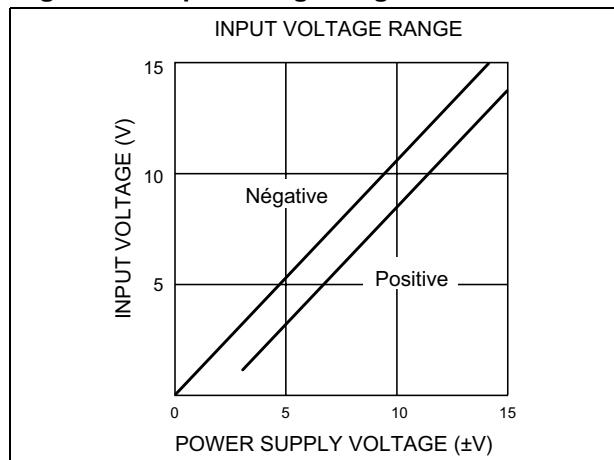
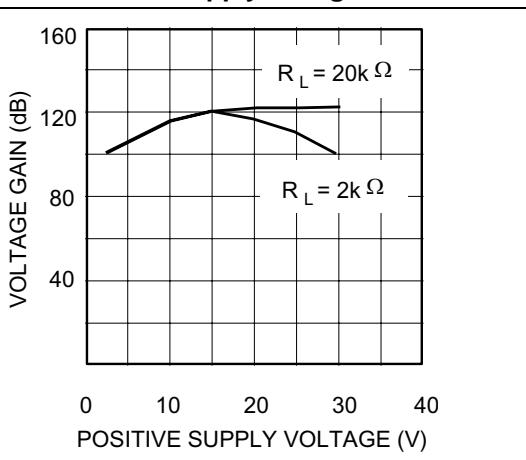
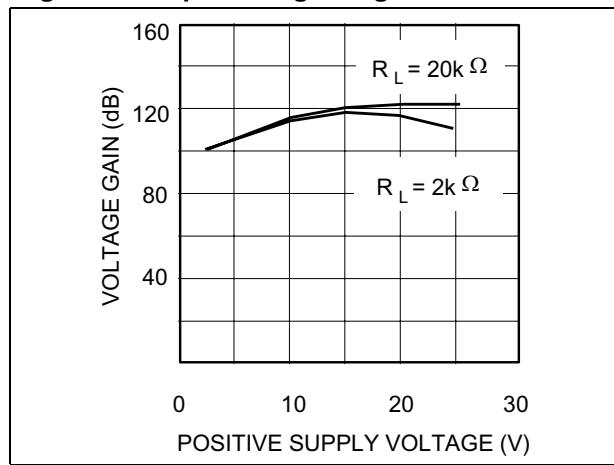
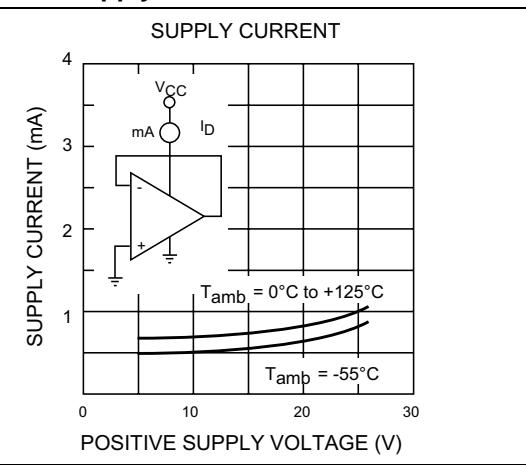
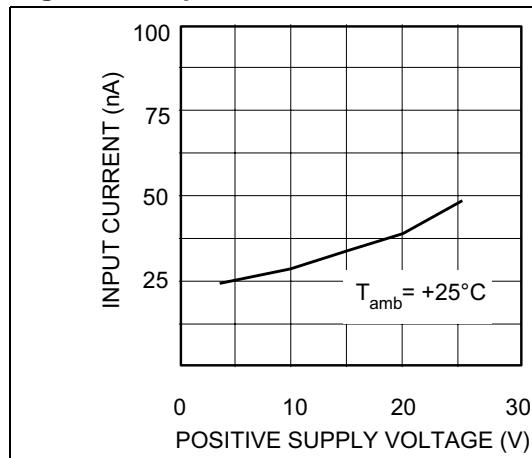
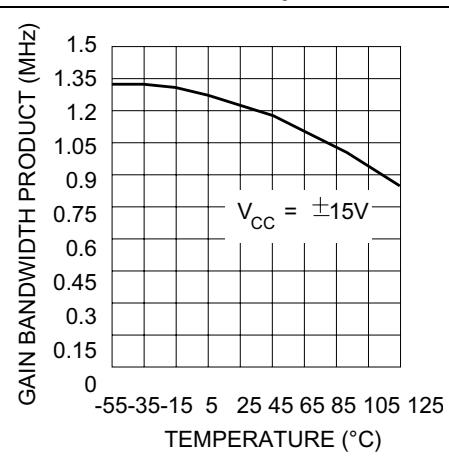
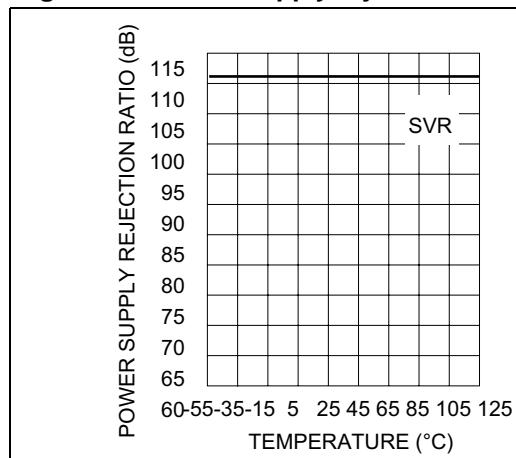
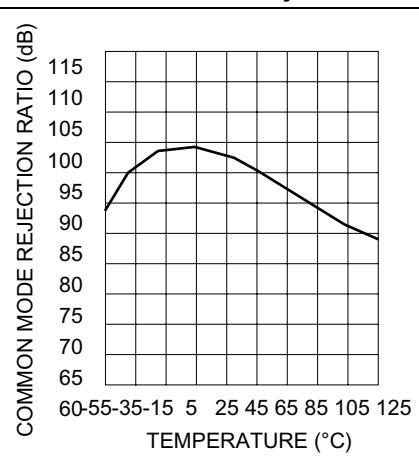
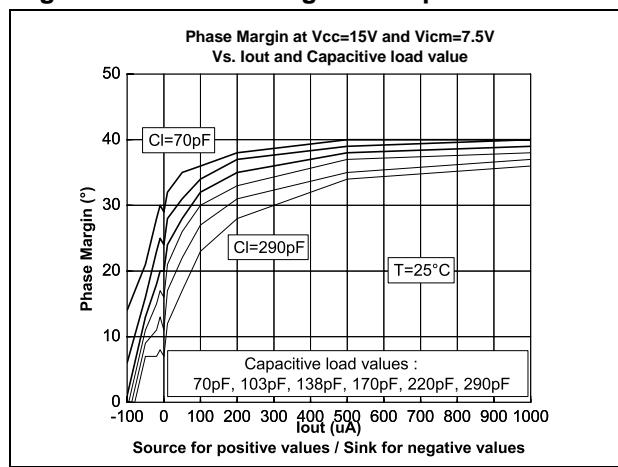
Figure 8. Output characteristics**Figure 9. Current limiting****Figure 10. Input voltage range****Figure 11. Positive supply voltage****Figure 12. Input voltage range****Figure 13. Supply current**

Figure 14. Input current**Figure 15. Gain bandwidth product****Figure 16. Power supply rejection ratio****Figure 17. Common mode rejection ratio****Figure 18. Phase margin vs. capacitive load**

4 Typical applications

Single supply voltage $V_{CC} = +5 \text{ V}_{DC}$

Figure 19. AC coupled inverting amplifier

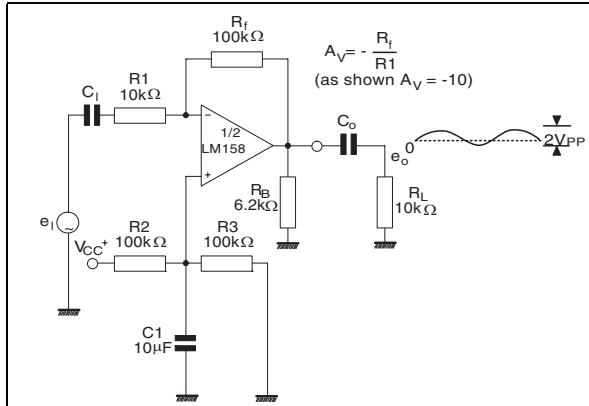


Figure 20. Non-inverting DC amplifier

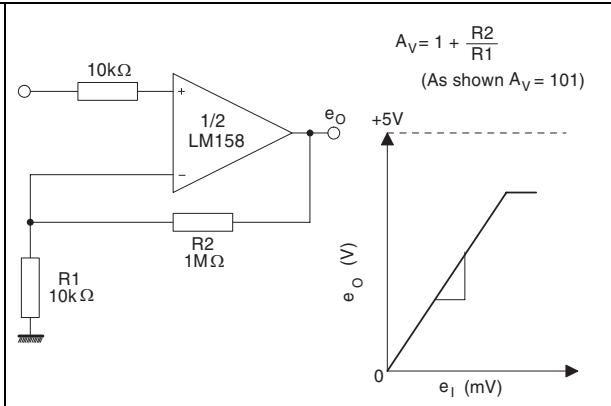


Figure 21. AC coupled non-inverting amplifier

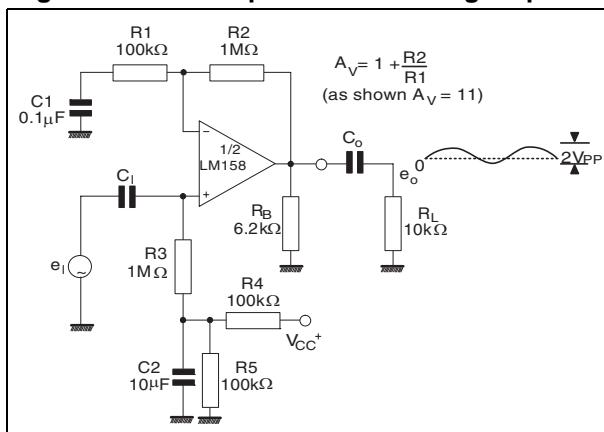


Figure 22. DC summing amplifier

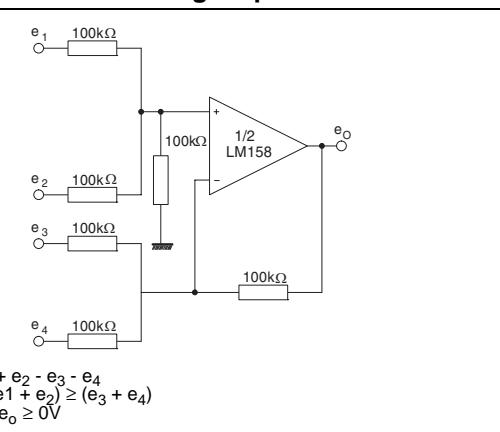


Figure 23. High input Z, DC differential amplifier

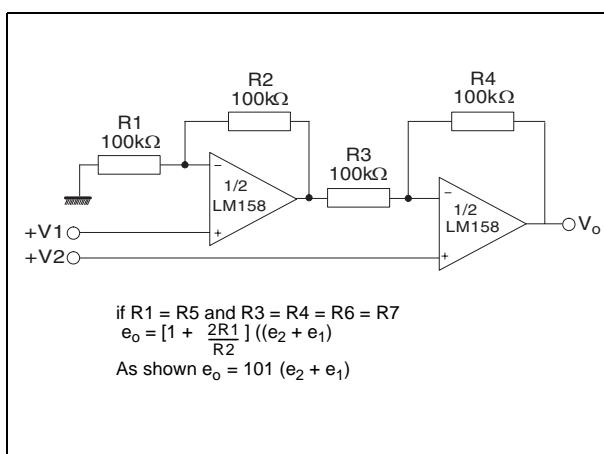


Figure 24. High input Z adjustable gain DC instrumentation amplifier

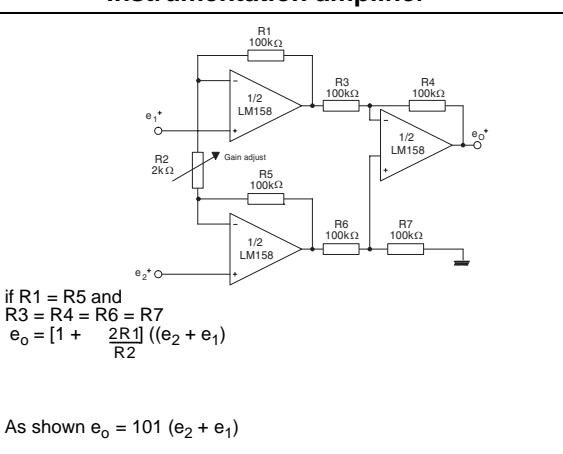


Figure 25. Using symmetrical amplifiers to reduce input current

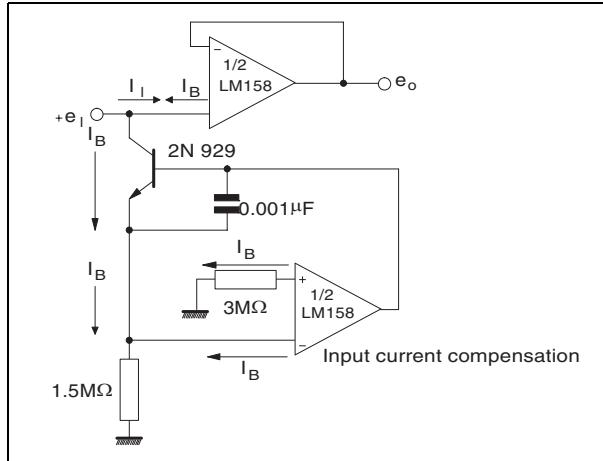


Figure 26. Low drift peak detector

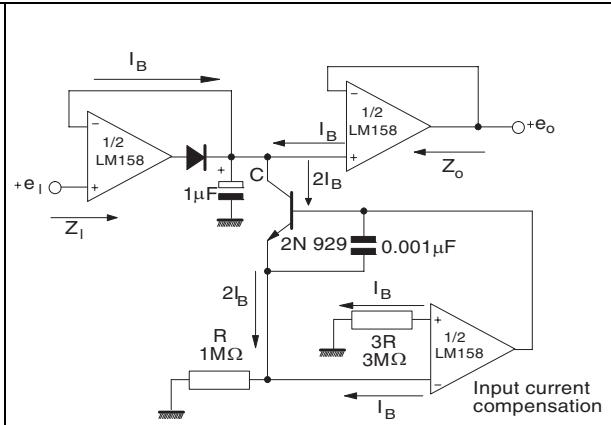
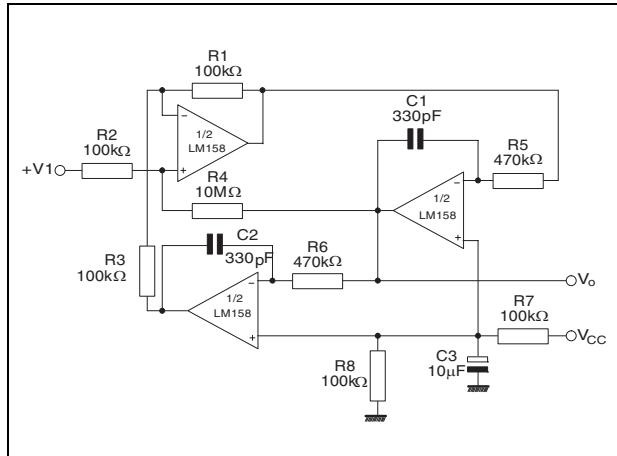


Figure 27. Active band-pass filter



5 Package information

In order to meet environmental requirements, STMicroelectronics offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an STMicroelectronics trademark. ECOPACK specifications are available at: www.st.com.

5.1 DIP8 package information

Figure 28. DIP8 package mechanical drawing

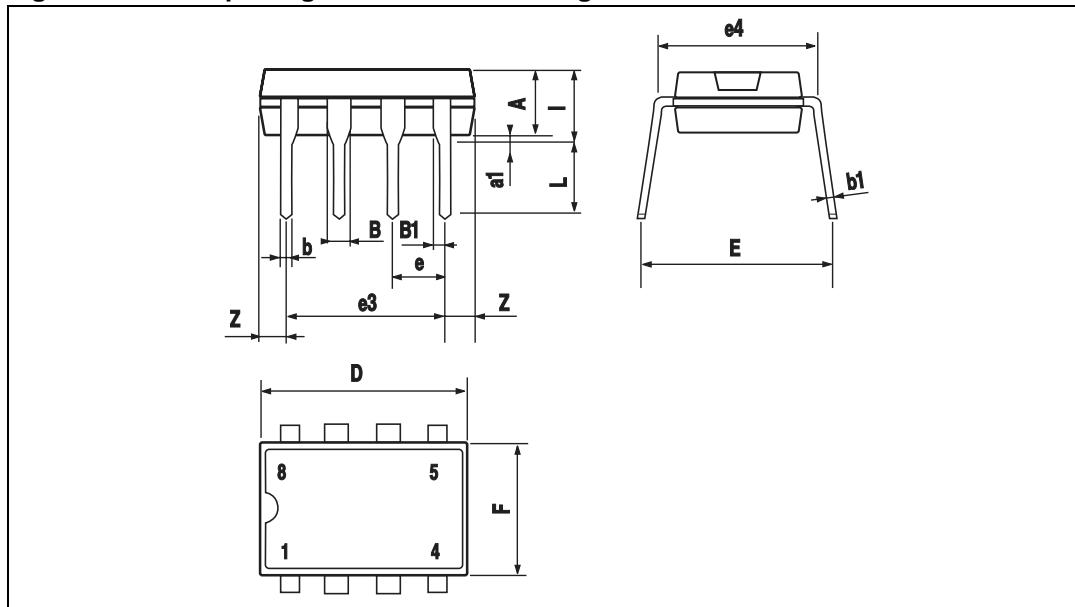


Table 4. DIP8 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A		3.3			0.130	
a1	0.7			0.028		
B	1.39		1.65	0.055		0.065
B1	0.91		1.04	0.036		0.041
b		0.5			0.020	
b1	0.38		0.5	0.015		0.020
D			9.8			0.386
E		8.8			0.346	
e		2.54			0.100	
e3		7.62			0.300	
e4		7.62			0.300	
F			7.1			0.280
I			4.8			0.189
L		3.3			0.130	
Z	0.44		1.6	0.017		0.063

5.2 SO-8 package information

Figure 29. Package mechanical drawing

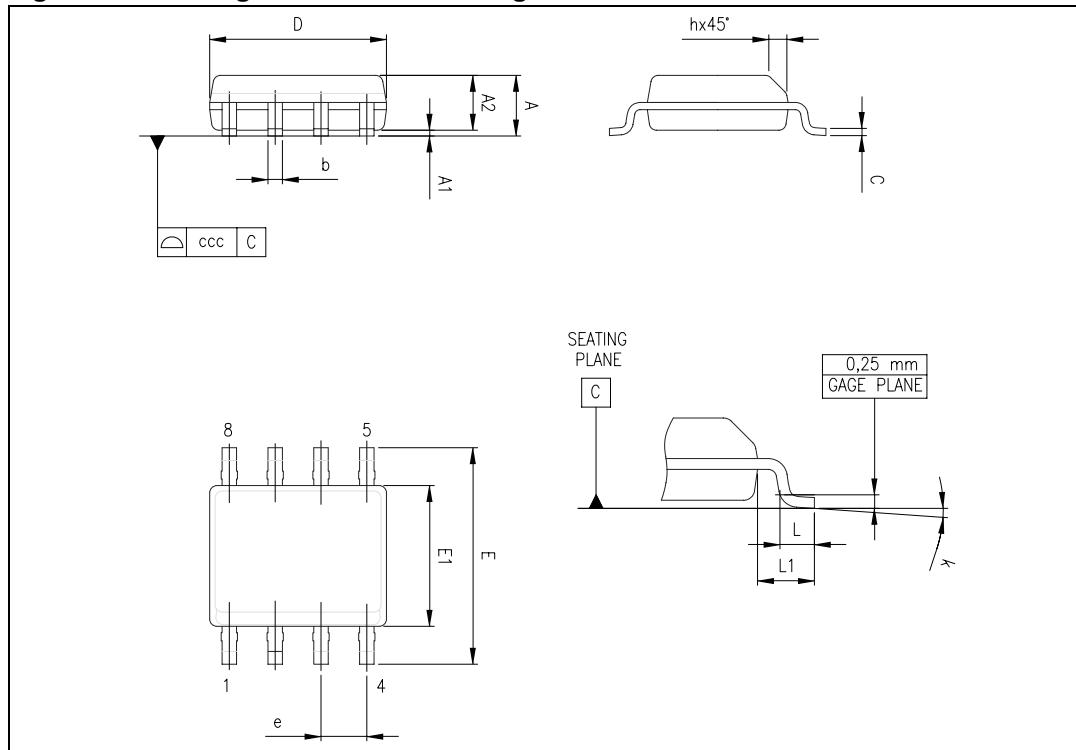


Table 5. Package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.069
A1	0.10		0.25	0.004		0.010
A2	1.25			0.049		
b	0.28		0.48	0.011		0.019
c	0.17		0.23	0.007		0.010
D	4.80	4.90	5.00	0.189	0.193	0.197
H	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
e		1.27			0.050	
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.050
k	1°		8°	1°		8°
ccc			0.10			0.004

5.3 MiniSO-8 package information

Figure 30. MiniSO-8 package mechanical drawing

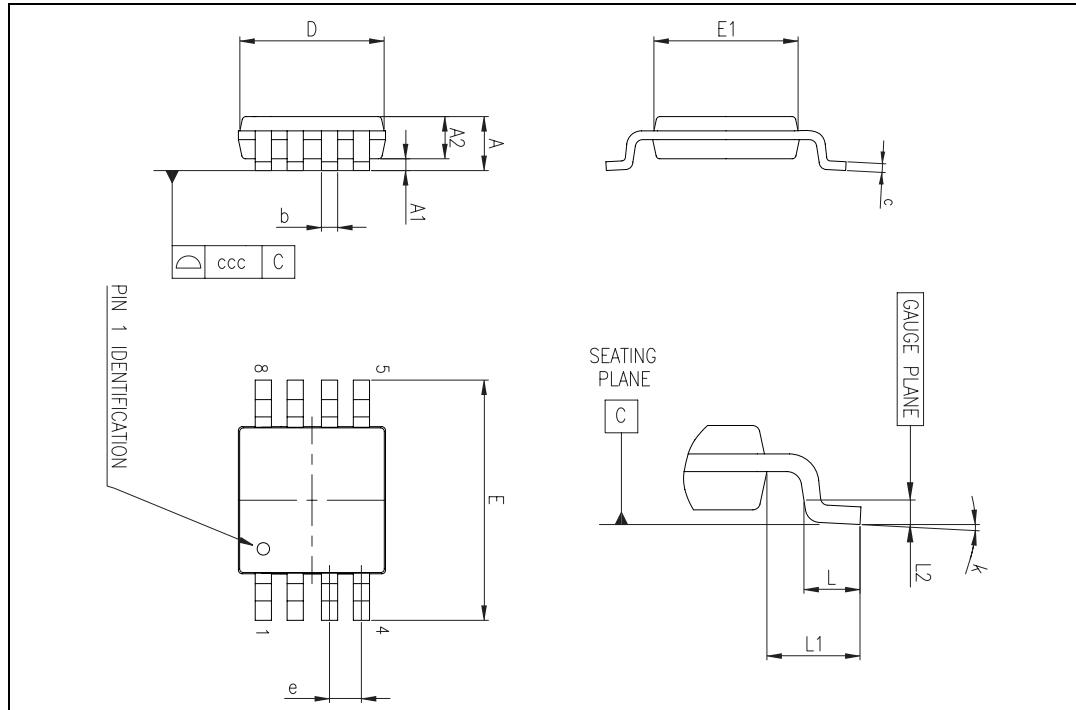
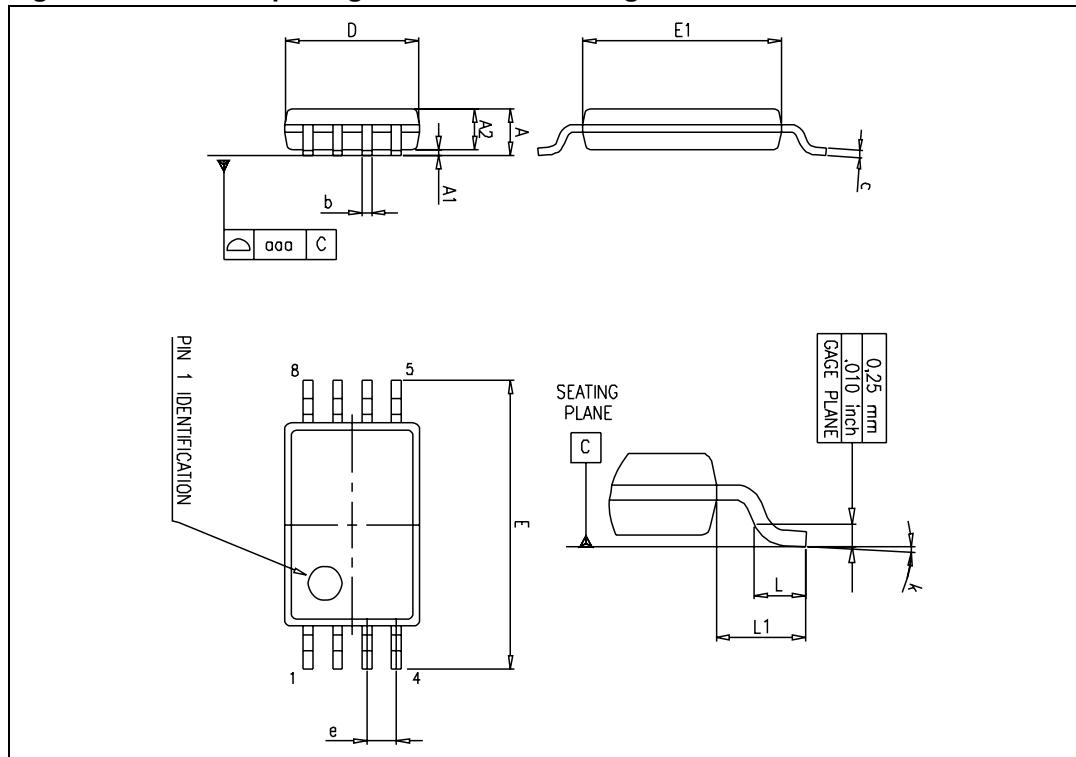


Table 6. MiniSO-8 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.1			0.043
A1	0		0.15	0		0.006
A2	0.75	0.85	0.95	0.030	0.033	0.037
b	0.22		0.40	0.009		0.016
c	0.08		0.23	0.003		0.009
D	2.80	3.00	3.20	0.11	0.118	0.126
E	4.65	4.90	5.15	0.183	0.193	0.203
E1	2.80	3.00	3.10	0.11	0.118	0.122
e		0.65			0.026	
L	0.40	0.60	0.80	0.016	0.024	0.031
L1		0.95			0.037	
L2		0.25			0.010	
k	0°		8°	0°		8°
ccc			0.10			0.004

5.4 TSSOP8 package information

Figure 31. TSSOP8 package mechanical drawing



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.2			0.047
A1	0.05		0.15	0.002		0.006
A2	0.80	1.00	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.008
D	2.90	3.00	3.10	0.114	0.118	0.122
E	6.20	6.40	6.60	0.244	0.252	0.260
E1	4.30	4.40	4.50	0.169	0.173	0.177
e		0.65			0.0256	
k	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030
L1		1			0.039	
aaa		0.1			0.004	

6 Ordering information

Table 7. Order codes

Order code	Temperature range	Package	Packaging	Marking
LM158WN	-55°C, +125°C	DIP-8	Tube	LM158WN
LM158WD LM158WDT		SO-8	Tube or tape & reel	158W
LM258WAN	-40°C, +105°C	DIP-8	Tube	LM258WA
LM258WAD LM258WADT		SO-8	Tube or tape & reel	258WA
LM258WN		DIP-8	Tube	LM258WN
LM258WD LM258WDT		SO-8	Tube or tape & reel	258W
LM258WYPT ⁽¹⁾	40°C, +105°C	TSSOP8 (Automotive grade)	Tape & reel	258WY
LM258AWYPT ⁽¹⁾		SO-8 (Automotive grade)		K410
LM258WYD ⁽²⁾ LM258WYDT ⁽²⁾		SO-8 (Automotive grade)	Tube or tape & reel	258WY
LM258AWYD ⁽²⁾ LM258AWYDT ⁽²⁾		SO-8 (Automotive grade)		258AWY
LM358WN	0°C, +70°C	DIP-8	Tube	LM358WN
LM358WD LM358WDT		SO-8	Tube or tape & reel	358W
LM358AWD LM358AWDT				358AW
LM358WYD ⁽²⁾ LM358WYDT ⁽²⁾	0°C, +70°C	SO-8 (Automotive grade)	Tube or tape & reel	358WY
LM358AWYD ⁽²⁾ LM358AWYDT ⁽²⁾		SO-8 (Automotive grade)		358AWY
LM358WYPT ⁽¹⁾		TSSOP8 (Automotive grade)	Tape & reel	358WY
LM358AWYPT ⁽¹⁾		TSSOP8 (Automotive grade)		K411

1. Qualification and characterization according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 & Q 002 or equivalent are on-going.
2. Qualified and characterized according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 & Q 002 or equivalent.

7 Revision history

Table 8. Document revision history

Date	Revision	Changes
01-Nov-2002	1	First release.
01-Jul-2005	2	ESD protection inserted in Table 1: Absolute maximum ratings on page 3 .
06-Oct-2006	3	ESD tolerance for model HBM improved to 2kV (Table 1: Absolute maximum ratings on page 3). R_{thja} and R_{thjc} typical values added in Table 1: Absolute maximum ratings on page 3 . Added Figure 18: Phase margin vs. capacitive load on page 9 .
02-Jan-2007	4	Order codes added (automotive grade level) to Section 6: Ordering information .
15-Mar-2007	5	Previously called revision 4. Footnote for automotive grade order codes added to Section 6: Ordering information .
25-Apr-2007	6	Added missing Revision 4 of January 2007 in revision history. Corrected revision number of March 2007 to Revision 5.
11-Feb-2008	7	Reformatted electrical characteristics table. Reformatted package information. Corrected MiniSO-8 package information. Corrected operating temperature range for automotive grade parts.

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